



(3583)

2017/12/13

## Safe Harbor Statement



- This Presentation contains certain forward-looking statements that are based on current expectations and are subject to known and unknown risks and uncertainties that could cause actual results to differ materially from those expressed or implied by such statements.
- Except as required by law, we undertake no obligation to update any forward –looking statements, whether as a result of new information, future events or otherwise.

## Scientech Corp (3583: TT)



Company Establishment	1979/10/17
IPO	2013/3/12
Capital	NT\$ 811 Million
Chairman	H.L. Hsieh
President	M.T. Hus
Products	Equipment Manufacturing · Wafer Reclaim · Trading(Agent/Distributor)



## Business Overvies

**Products** 

Future Prospect

## Business Overview

## **Income Statement**



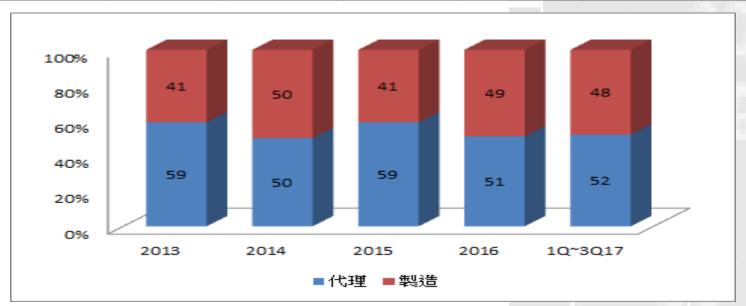
Units: NT \$ M	2013	2014	2015	2016	3Q17	1Q~3Q17
Revenues	3,068	2,717	2,942	3,495	885	2,428
Gross Profit	983	970	903	1,178	335	864
Operating Expenses	629	673	779	835	215	611
Operating Income	354	297	124	343	120	253
Other Income and Expenses	(26)	20	(6)	21	(15)	(26)
Income Before Tax	328	317	119	363	105	227
Net Income	249	246	86	292	86	177
EPS	3.11	3.04	1.06	3.60	1.06	2.18
Gross Margin	32.04%	35.71%	30.69%	33.71%	37.91%	35.60
Operating Margin	11.53%	10.93%	4.23%	9.80%	13.62%	10.44%
Income Before Tax margin	10.69%	11.68%	4.03%	10.40%	11.86%	9.33%

## Business Overview

## **Products Mix**



Units: %	2013	2014	2015	2016	1Q~3Q17	Gross Margin
Trading	59	50	59	51	52	Below Average
Manufacturing	41	50	41	49	48	Above Average



## Business Overview

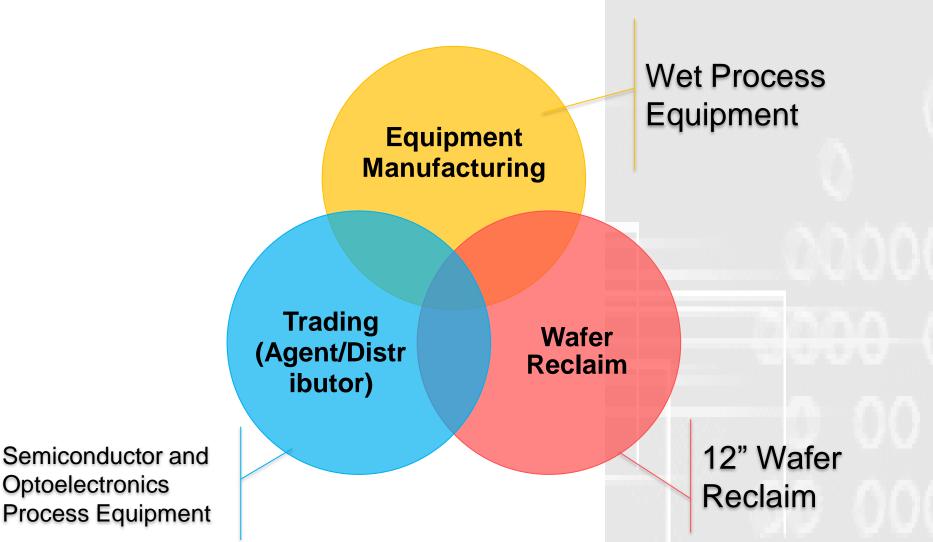
## **R&D Expenses**



Units: NT \$ M	2013	2014	2015	2016	1Q~3Q17
R&D Expenses	131	160	196	226	171
Expenses as % of Revenue	4.27%	5.89%	6.66%	6.48%	7.06%







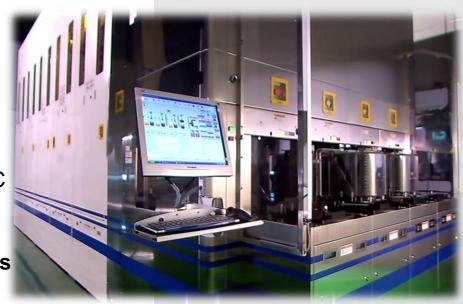
**Optoelectronics Process Equipment** 

# Equipment Manufacturing



#### Wet process equipment

- Single wafer/ Batch type
  - 8"/12' Advanced packaging
     (Fan-out · Solder Bump ·
     Copper Pillow · Bumping ·
     Gold Bump · RDL · TSV
     ...ect)
  - 6"/ 8"/12" Front-end special process (IoT Sensor · Power IC FP sensor · RF · CMOS · Touch Controller · MEMS)
  - HB LED fully-automatic process
  - MEMS
  - III-V



Line

#### Si Wafer Reclaim



**Advanced clean technology Complete particle inspection** 20nm/ 16nm Particle (SP1-DLS & SP2) **Low trace metal (<5E9)** 12" Wafer Reclaim Etching Cleaning Capacity: 120K / month Separated Cu & Non Cu Full Process **Optimization Grindin**ışı Rolishing

> **Complete polishing process** Single side polish Double side polish **Final Haze polish**

**Super flatness** (GBIR<0.5µm)

## **Trading** (Agent/Distributor)









**ECO-SNOW** SYSTEMS























Multi applicati on

Exclusive Agency

Supply Chain Partnership























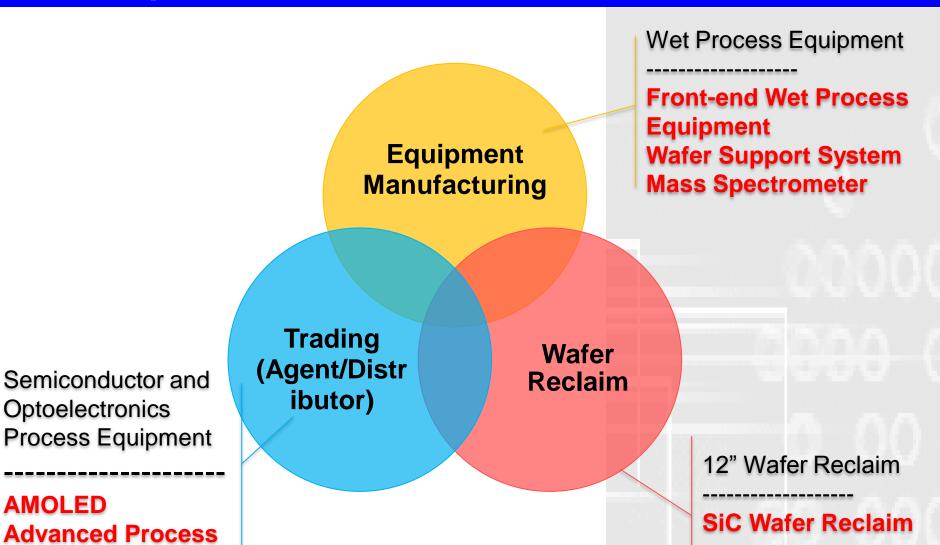
## Future Prospect

**Miniaturization** 

## Product-based Extension



12









## **All** acromass

AMS-200-1 inTrap MALDI Mass Spectrometer

Range: 500-500kDa
Resolution: 10Da@100kDa
Precision: 100Da@100kDa
(for intact protein analysis)



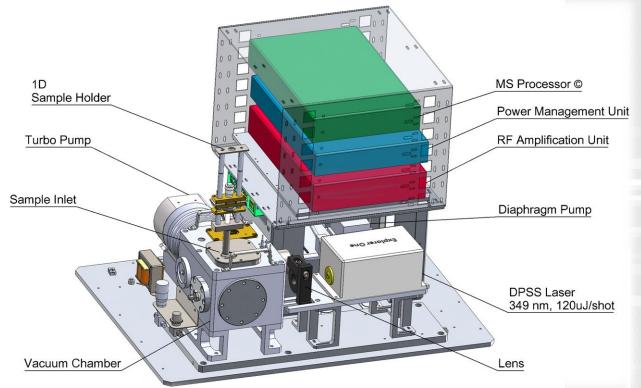
### **Highly Integrated System**



AMS-200-1



# Without any external pump & gas cylinder, all modules are consolidated in a desktop!



Size:

60 cm W

x 50 cm D

x 50 cm H

Weight:

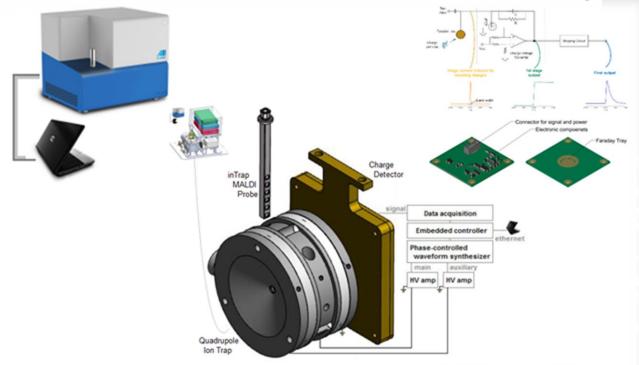
< 40 Kg



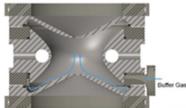
## **Compact & Novel Design**



# High-precision miniature assembly of all-homemade key components ---



-100000



multiple sample inlet!

high-precision mass analyser!

3D-printed Knudsen-flow gas nozzle!

&

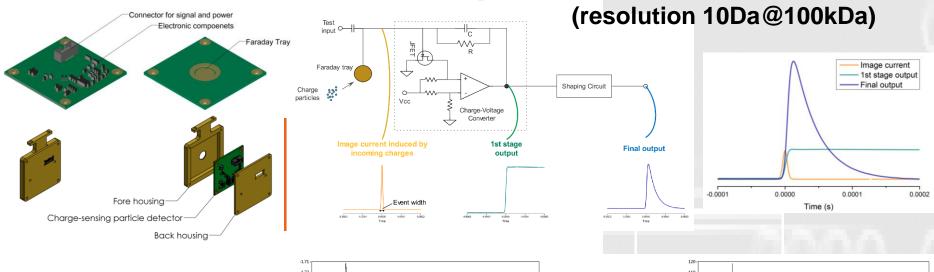
highly sensitive charge detector !!

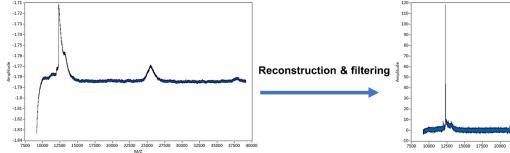


### **Charge Sensing Particle Detector**



# "Very-Simple" proprietary charge detector ... no HV bias, no high vacuum required!





#### Raw 1<sup>st</sup> stage of CSPD<sup>™</sup> signal

- Good response to ion quantity.
- It consists of ion information and circuit property as the falling of peak.

#### Reconstructed & filtered signal

- The circuit property has removed. The signal responding to the detecting ions.
- Bad linearity to ion number



NI sbRIO

9626/9627

Start

Idle

Aux Scan

**FPGA** 

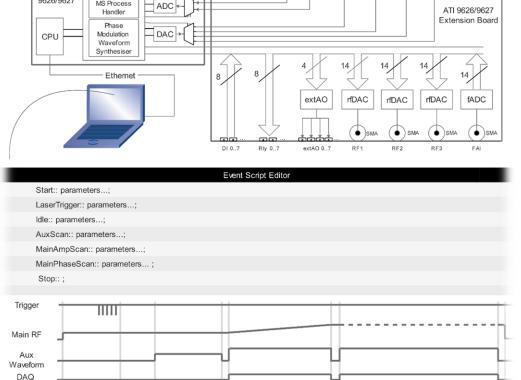
MS Process

### **Phase-Synthesized MS Platform**



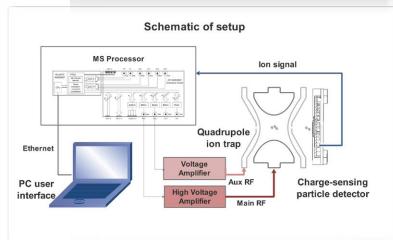
#### Versatile waveform via ion-trap dynamics for proprietary mass spectrometry

Main RF Phase Scan



Main RF Amplitude

0000

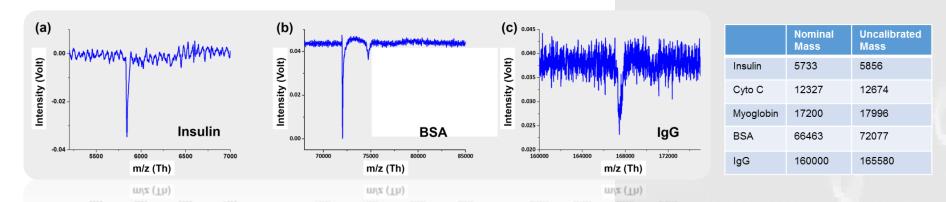


frequency jitter ~ 1e-4!!

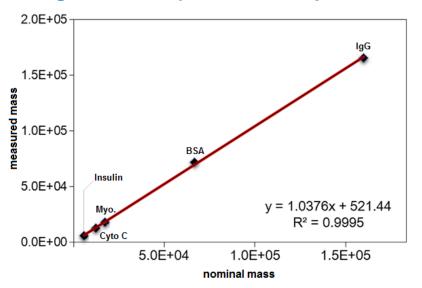


## Wide & Linear Mass Range





Uncalibrated MALDI ion trap mass spectra of (a) insulin (5808 Da), (b) bovine serum albumin (BSA, 66.5k Da), and (c) immunoglobulin G (IgG from bovine serum, ~160k Da, Sigma-Aldrich). The mass spectra use unstable ejection with the main RF phase scan.



Robust extension of mass range over 3 orders of magnitude ...

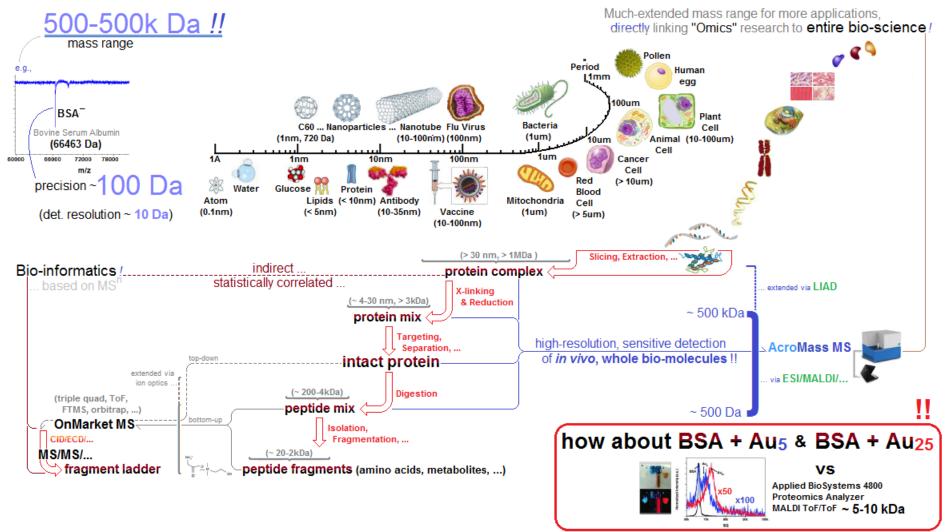
500-500kDa!



#### **Bio-Medical/Nano-Material Market**



#### High-resolution intact protein analysis



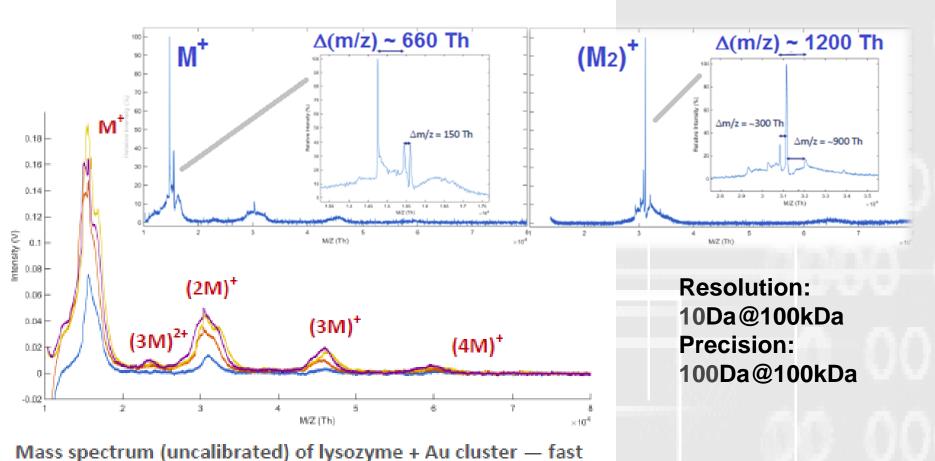




#### High-resolution intact protein analysis

screening of charge state (1st stage CSPD signal)

Lysozyme-stab. gold nanoclusters (Lys-AuNCs) as functional nanomaterials



## **Q & A**





## **Thank You!**